

NB3L02

2.8 V, High Precision 1:2 Clock Fanout Buffer

Description

The NB3L02 is a low-skew, low jitter 1:2 clock fanout buffer, ideal for use in portable end-equipment, such as mobile phones or tablet applications. The MCLK_IN pin has an integrated AC coupling capacitor and will directly accept a square or sine wave clock input, such as a temperature compensated crystal oscillator (TCXO). The minimum acceptable input amplitude of the sine wave is 800 mV peak-to-peak. The NB3L02 is offered in a 0.4 mm pitch 6-ball, wafer-level chip-scale package (WLCSP) (0.77 mm x 1.17 mm).

Features

- 800 mV Single Ended Outputs
- Low Phase Noise: -144 dbc/Hz @ 10 kHz Offset
- Ultra Small Package: 0.4 mm Pitch WLCSP6 (0.77 mm x 1.17 mm)
- Exceeds JEDEC ESD Standards: 4000 V HBM, 200 V MM
- Industrial Temperature Range: -40°C to +85°C
- These are Pb-Free Devices

PIN DESCRIPTIONS

Ball No.	Name	I/O	Description
A1	V _{DD}	I	Power Supply Voltage
A2	CLK_OUT1	O	Clock Output 1
B1	MCLK_IN	I	Master Clock Input
B2	GND	-	Ground
C1	GND	-	Ground
C2	CLK_OUT2	O	Clock Output 2



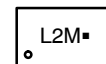
ON Semiconductor®

<http://onsemi.com>



WLCSP6
FC SUFFIX
CASE 567HJ

MARKING DIAGRAM



L2 = Specific Device Code
M = Date Code
▪ = Pb-Free Package

PINOUT DIAGRAM

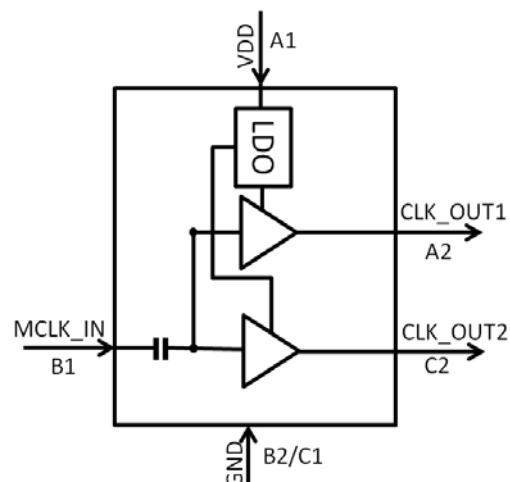
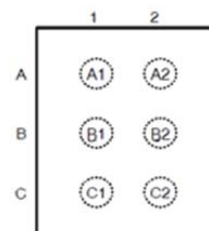


Figure 1. Simplified Block Diagram

ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 3 of this data sheet.

NB3L02

Table 1. MAXIMUM RATINGS

Symbol	Parameter	Condition	Min	Max	Unit
	Voltage Range (Note 1)	MCLK_IN, CLK_OUT1, CLK_OUT2	-0.3	V _{DD} + 0.3	V
IO	Continuous Output Current	CLK_OUT1/2		±20	mA
T _J	Operating Junction Temperature Range		-40	150	°C
T _{stg}	Storage Temperature Range		-55	150	°C

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

1. All voltage values are with respect to network ground terminal.

Table 2. ATTRIBUTES

Characteristic		Value
ESD Protection	Human Body Model	>4 kV
	Machine Model	>200 V
Moisture Sensitivity	WLCSP6	Level 1
Maximum Soldering Temperature for Lead-free Devices Using a Lead-free Solder Paste		260
Flammability Rating Oxygen Index: 28 to 34		UL 94 V-0 @ 0.125 in
Transistor Count		149
Meets or Exceeds JEDEC Spec EIA/JESD78 IC Latchup Test II		

Table 3. ELECTRICAL CHARACTERISTICS (T_A = -40°C to +85°C)

Symbol	Characteristic	Min	Typ	Max	Unit
V _{DD}	Supply Voltage	2.3	2.8	3.465	V
V _{IN}	Input Voltage p-p	800		V _{DD}	mV
V _{OUT}	Output Voltage p-p	0.6	0.8	1.0	V
I _{DDdynamic}	Dynamic Current at 26 MHz		3.5	5	mA
F _{IN}	MCLK_IN Frequency Range with 800 mV input p-p	10	26	52	MHz
t _{PD}	MCLK_IN to CLK_OUT_n Propagation Delay, input = 1 Vp-p @ 26 MHz	2.0	4.0	6.5	ns
DC	CLK_OUT_n Duty Cycle	45	50	55	%
-	Phase Noise, F _{IN} = 26 MHz, input t _r /t _f < 1 ns 1 kHz Offset 10 kHz Offset 100 kHz Offset		-134 -144 -148		dbc/Hz dbc/Hz dbc/Hz
t _r /t _f	Output Rise Time 20%-80% with 10 pF Load, V _{IN} = 800 mVp-p, 26 MHz, input slew rate < 1 ns/V	0.5	0.8	1.2	ns
t _{sk}	Channel to Channel Skew		10	30	ps
V _{oh}	High Level Output (V _{oh} -V _{ol} not to exceed V _{OUT})	0.6	0.8	1.0	V
V _{ol}	Low Level Output (V _{oh} -V _{ol} not to exceed V _{OUT})		0		V

NB3L02

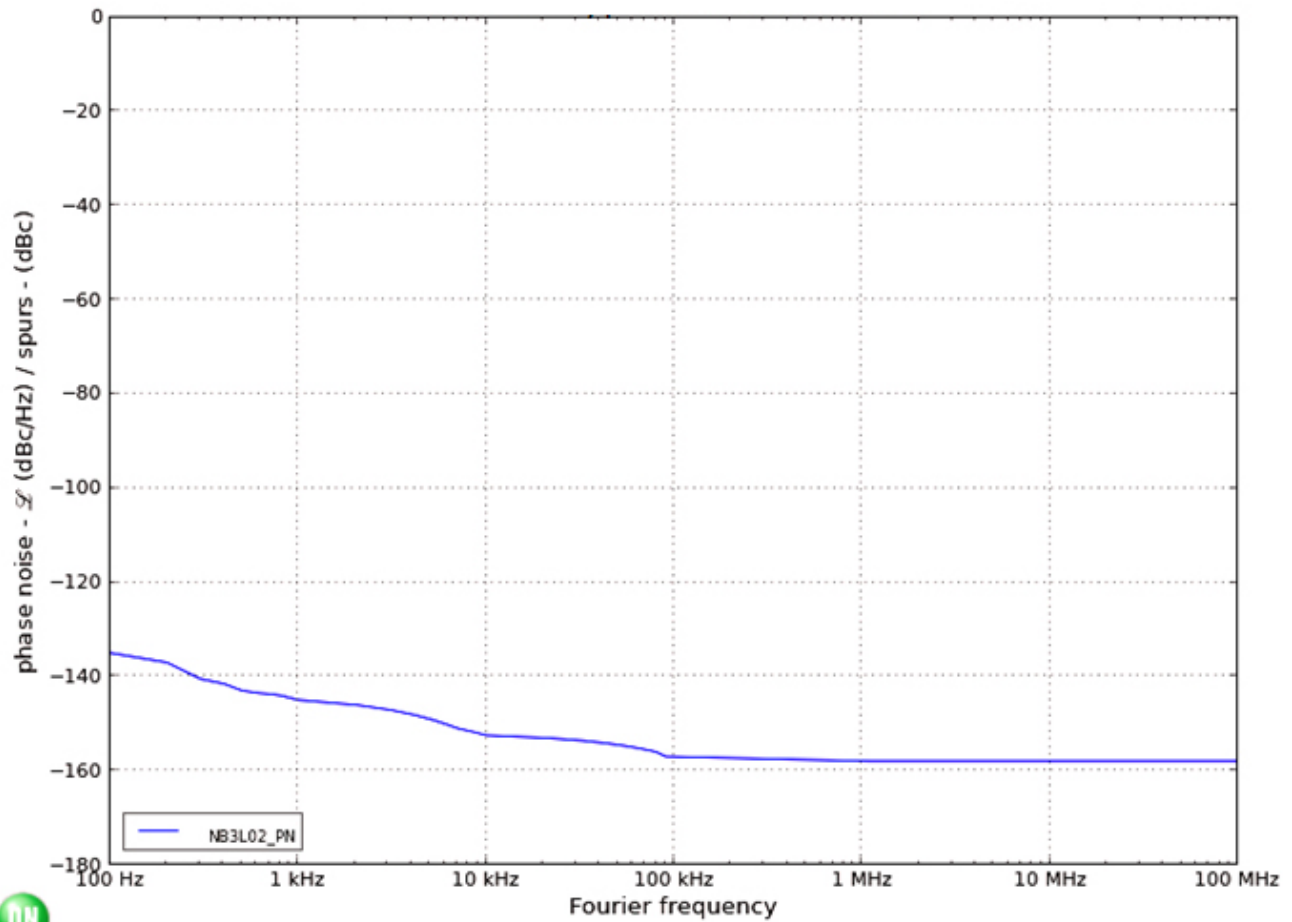


Figure 2. Typical Phase Noise

ORDERING INFORMATION

Device	Package	Shipping [†]
NB3L02FCT2G	WLCSP6 (Pb-Free)	3000 / Tape & Reel

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

MECHANICAL CASE OUTLINE

PACKAGE DIMENSIONS

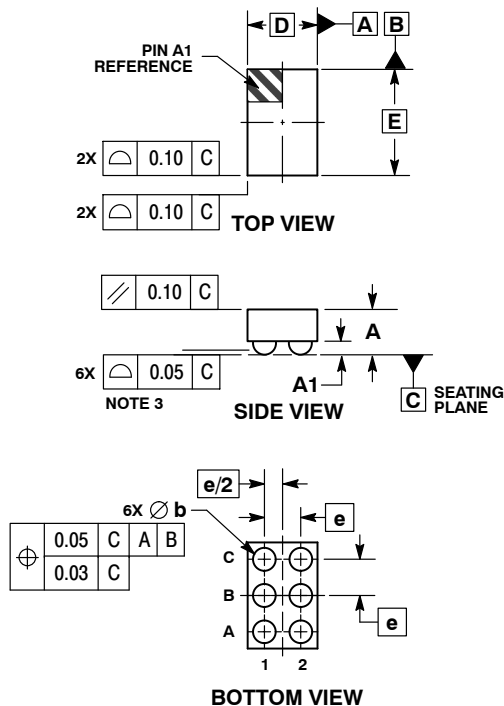
ON Semiconductor®



SCALE 4:1

WLCSP6, 1.17x0.77
CASE 567HJ
ISSUE O

DATE 28 MAY 2013

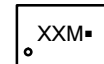


NOTES:

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: MILLIMETERS.
3. COPLANARITY APPLIES TO SPHERICAL CROWNS OF SOLDER BALLS.

MILLIMETERS		
DIM	MIN	MAX
A	---	0.50
A1	0.13	0.17
b	0.21	0.25
D	0.77	BSC
E	1.17	BSC
e	0.40	BSC

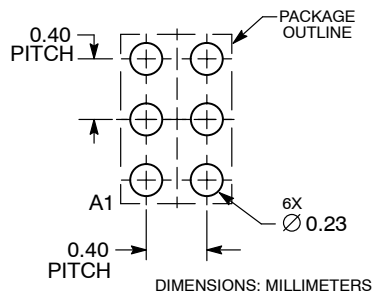
GENERIC MARKING DIAGRAM*



- XX = Specific Device Code
M = Date Code
▪ = Pb-Free Package

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "▪", may or may not be present.

RECOMMENDED SOLDERING FOOTPRINT*



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

DOCUMENT NUMBER:	98AON89478E	Electronic versions are uncontrolled except when accessed directly from the Document Repository. Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red.
DESCRIPTION:	WLCSP6, 1.17X0.77	PAGE 1 OF 1

ON Semiconductor and are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. ON Semiconductor does not convey any license under its patent rights nor the rights of others.

ON Semiconductor and  are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights nor the rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor products for any such unintended or unauthorized application, Buyer shall indemnify and hold ON Semiconductor and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that ON Semiconductor was negligent regarding the design or manufacture of the part. ON Semiconductor is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:

Email Requests to: orderlit@onsemi.com

ON Semiconductor Website: www.onsemi.com

TECHNICAL SUPPORT

North American Technical Support:

Voice Mail: 1 800-282-9855 Toll Free USA/Canada

Phone: 011 421 33 790 2910

Europe, Middle East and Africa Technical Support:

Phone: 00421 33 790 2910

For additional information, please contact your local Sales Representative

